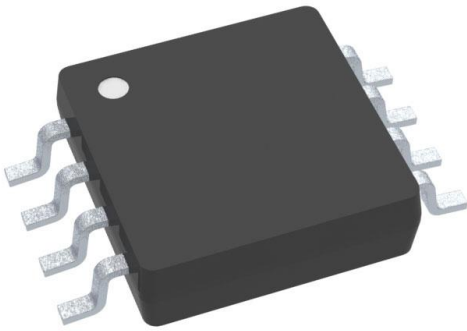


# INA284AIDGKR Datasheet

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DiGi Electronics Part Number	INA284AIDGKR-DG
Manufacturer	<a href="#">Texas Instruments</a>
Manufacturer Product Number	INA284AIDGKR
Description	IC CURRENT MONITOR 0.4% 8VSSOP
Detailed Description	Current Monitor Regulator High/Low-Side 8-VSSOP



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## Purchase and inquiry

Manufacturer Product Number:

INA284AIDGKR

Series:

Zero-Drift

Function:

Current Monitor

Accuracy:

±0.4%

Current - Output:

-

Mounting Type:

Surface Mount

Supplier Device Package:

8-VSSOP

Manufacturer:

Texas Instruments

Product Status:

Active

Sensing Method:

High/Low-Side

Voltage - Input:

-14V ~ 80V

Operating Temperature:

-40°C ~ 125°C

Package / Case:

8-TSSOP, 8-MSOP (0.118", 3.00mm Width)

Base Product Number:

INA284

## Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.39.0001

Moisture Sensitivity Level (MSL):

2 (1 Year)

ECCN:

EAR99



# TI Designs

## EMC Compliant High Side Current Sensing with Overvoltage Protection



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### Design Resources

[TIDA-00126](#)  
[INA282](#)

Design Files  
Product Folder



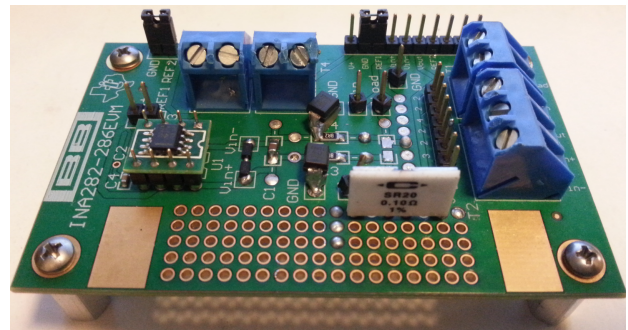
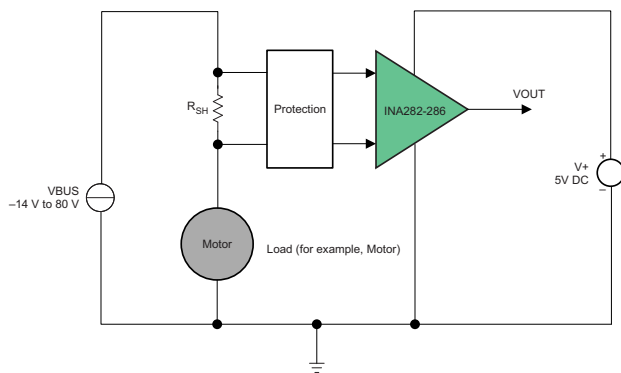
[ASK Our Analog Experts](#)  
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### Design Features

- Wide common mode input range:  $-14\text{ V}$  to  $80\text{ V}$
- Overvoltage protection:  $45\text{ V}$
- EFT protection up to  $1\text{ kV}$  as per IEC61000-4-4
- $> 130\text{ dB}$  Common Mode Rejection Ratio (CMRR) for DC-10 Hz
- Overall accuracy better than 2%
- $70\text{-}\mu\text{V}$  offset and 1.4% gain error

### Featured Applications

- Factory automation: PLC 24-V DC bus current monitoring
- 24-V system/board level current sensing
- Bi-directional motor control
- Smart battery packs and chargers
- Solar inverters
- 28-V auxiliary input current measurement for aerospace
- Electric hybrid vehicles



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## 1 Overview

High-side precision current sensing is widespread - from industrial equipment like protection relays, solenoid or motor control, test equipment and solar inverters to consumer equipment like smart phones, tablets, servers and battery chargers. Engines can use the amount of current being delivered to a load to make safety-critical decisions and avoid failures due to overcurrent or short-circuit conditions by maintaining the load current within safe operating limits.

This reference design focuses on EMC-compliant high-side current sense solutions using the INA282, INA283, INA284, INA285, and INA286 family of voltage output current shunt monitor devices. These devices help designers achieve highly-accurate current-monitoring solutions in a wide range of common-mode voltages from  $-14\text{V}$  to  $+80\text{V}$ . This device family also supports bi-directional operation that may be required in battery operated equipment where charging and discharging currents need to be monitored. Clearly, these devices are likely to encounter very high and dynamic changes in common mode voltages when accessing their power supplies. This ability is useful in applications when current shunt monitor devices must interface with a low-voltage analog-to-digital converter (ADC). In such a scenario, both the current shunt monitor device and the ADC can be powered with the same supply voltage regardless of the system's common-mode voltage.

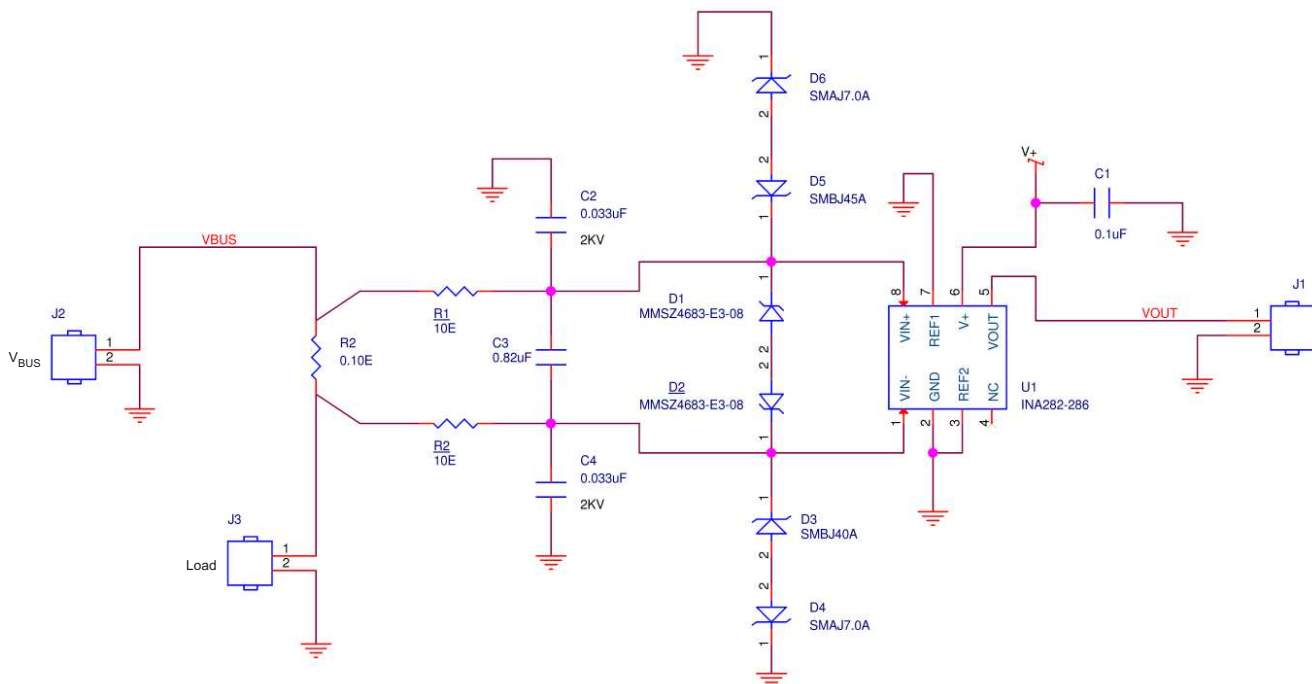
## 2 Design Specifications

The high-side current sense is designed to meet the following specifications:

- Load supply up to 24 V
- Overvoltage protection up to 45 V
- Device supply voltage of 5 VDC
- 1 kV electrical fast transient (EFT) withstanding capability
- Overall accuracy better than 2%

## 3 Circuit Diagram

A circuit diagram of high-side current sensing with improved transient immunity is shown in [Figure 1](#).



**Figure 1. High-Side Current Sensing with Improved Transient Immunity**

## 4 Theory of Operation

The system implementing high-side current sensing puts a shunt resistor between the supply voltage ( $V_{BUS}$ ) and the load. High-side current sensing is desirable as any downstream failure can be detected and appropriate corrective action can be triggered. High-side current sensing can be seen as a small sense voltage riding on top of a high common mode voltage. That is why high-side current shunt monitors must have a common mode voltage range outside the load's supply voltage and a very high CMRR. Current sense monitors encounter high voltage transients and overvoltage events frequently in the fields.

Transient voltage can cause severe damage and failure of the device. Overcoming unwanted damaging transient threats is one of the biggest challenges in the design. Therefore, adding robust EMC protection externally becomes a necessity. The EMC protection circuit should protect the device from the transient high voltages and maintain stable output to keep the circuit working even when transient conditions occur.

The INA282-286 devices are voltage output, high-side measurement, unidirectional and bi-directional, and zero-drift current shunt monitors. This family of devices has predetermined gains that range from 50 V/V to 1000 V/V. The corresponding gain of the specific device amplifies the voltage developed across the device inputs. The output pin presents the voltage. The INA282-286 devices can sense voltage drops across shunts at common-mode voltages between  $-14$  V to 80 V, independent of supply voltages and 140 dB CMRR (Typical). These devices operate with supply voltages between 2.7 V and 18 V and draw a maximum of 900- $\mu$ A supply current. The INA282-286 devices are used for accurate measurements well outside of their own power-supply voltages ( $V+$ ). For example, the  $V+$  power supply can be 5 V while the common-mode voltage may be as high as +80 V.

The output of the device is proportional to the current through the sense resistor:

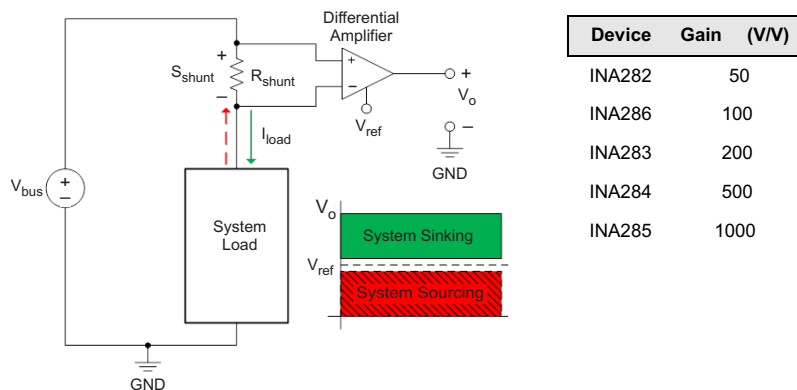
$$V_{OUT} = (\text{GAIN} \times R_{SH} \times I_{LOAD}) + V_{REF} = \text{GAIN} \times V_{SH} + V_{REF}$$

Where,  $V_{REF}$  is the average of  $V_{REF1}$  and  $V_{REF2}$ .

**Note:**  $V_{REF1}$  and  $V_{REF2}$  control the  $V_{OUT}$  level for bi-directional operation. Make sure  $V_{REF}$  is sufficiently high such that output voltage does not exceed the allowed output swing of the device. The output voltage swings above  $V_{REF}$  for positive sense current direction and below  $V_{REF}$  for negative sense current direction. The output voltage stays at  $V_{REF}$  when  $V_{SH}$  is zero.

For unidirectional current sensing, REF1 and REF2 pins connect to the ground. Then, represent output voltage as:

$$V_{OUT} = \text{GAIN} \times R_{SH} \times I_{LOAD} = \text{GAIN} \times V_{SH}$$



**Figure 2. Typical High Side Current Sensing**

#### 4.1 Sizing Shunt Resistor ( $R_{SH}$ )

Selection of the correct sense resistor is vital for accurate current measurement in an application. To determine the size of the shunt resistors, the following parameters must be known:

- Full scale load current
- Available supply voltage for the device ( $V+ = 5$  VDC)
- Minimum load voltage requirement (or maximum permissible voltage loss in the measurement line)
- Accuracy

Resolve trade-offs while selecting and calculating the optimum value of  $R_{SH}$ :

Increasing  $R_{SH}$  increases the  $V_{SH}$ , which provides better accuracy because voltage offset and input bias current errors become less significant.

**versus** A large  $R_{SH}$  value increases the  $I^2 \times R$  losses which in-turn increases self-heating and changes the value of  $R_{SH}$  and also causes higher voltage loss that must meet the load's minimum voltage requirement.

Increasing  $R_{SH}$  increases the  $V_{SH}$  which must not exceed the input voltage swing specified by the device.

**versus** The minimum value of  $R_{SH}$  is set by input dynamic range, input offset voltage, and resolution requirements.

Tighter tolerance, low TCR, low thermal EMF, 2-pin or 4-pin sense resistor, all need a very low inductance resistor if the current being sensed contains high-frequencies. (Wire-wound resistors have higher inductance compared to metal-film resistors.)

**versus** Cost

##### Step 1: Output Voltage Swing

Find the output voltage swing from the device datasheet, which is:

$(GND + 0.4 \text{ V}) < V_{OUT} < (V+ - 0.4 \text{ V})$ ; where  $V+$  is 5 VDC

$0.4 \text{ V} < V_{OUT} < 5 \text{ V} - 0.4 \text{ V}$

**Output voltage swing:  $0.4 \text{ V} < V_{OUT} < 4.6 \text{ V}$**

##### Step 2: Input Sense Voltage Range

Refer the above relation to input by dividing it with device gain. For the INA282 device, the gain is 50 V/V.

**Input sense voltage ( $V_{SH}$ ) range:  $800 \mu\text{V} < V_{SH} < 92 \text{ mV}$**  for the given power supply ( $V+$ ) of 5 V

##### Step 3: Maximum Sense Resistor

If a peak load current of 0.8 A is expected in an application and the maximum input sense voltage  $V_{SH (MAX)}$  must not exceed 92 mV, use this formula:

$$R_{SH (MAX)} = \frac{V_{SH (MAX)}}{I_L (MAX)} = \frac{92 \text{ mV}}{0.8 \text{ A}} = 115 \text{ m}\Omega \quad (1)$$

Choose a value for the reference design:  **$R_{SH (MAX)} = 100 \text{ m}\Omega$** .

**Note:** For most applications, the best performance is attained with an  $R_{SH}$  value that provides a full-scale sense voltage.

##### Step 4: Minimum Load Current

Find the minimum load current  $I_L (MIN)$ :

Either the total error budget of the device or the minimum input sense voltage  $V_{SH (MIN)} = 800 \mu\text{V}$  (whichever is more) limits the minimum load current ( $I_L (MIN)$ ) that can be accurately represented by the INA282.

$$I_L (MIN) = \frac{V_{SH (MIN)}}{R_{SH}} = \frac{800 \mu\text{V}}{100 \text{ m}\Omega} \quad (2)$$

**$I_L (MIN) = 8 \text{ mA}$**

So, the minimum load current ( $I_{L (MIN)}$ ) producing change in the output voltage is greater than or equal to 8 mA.

**Step 5: Maximum Power Dissipation**

Maximum Power Dissipation:  $P_{SH (MAX)} = I_{L (MAX)}^2 \times R_{SH} = (0.8 \text{ A} \times 0.8 \text{ A}) \times 100 \text{ m}\Omega$

**$P_{SH (MAX)} = 64 \text{ mW}$**

Select a sense resistor having maximum power dissipation more than 64 mW.

**Note:** If the engineer allows the sense resistor to dissipate more power, the sense resistor heats up and its maximum power distribution value drifts.

**Step 6: Voltage Loss**

Find the maximum voltage loss caused by the sense resistor using ( $R_{SH}$ ) using this formula:

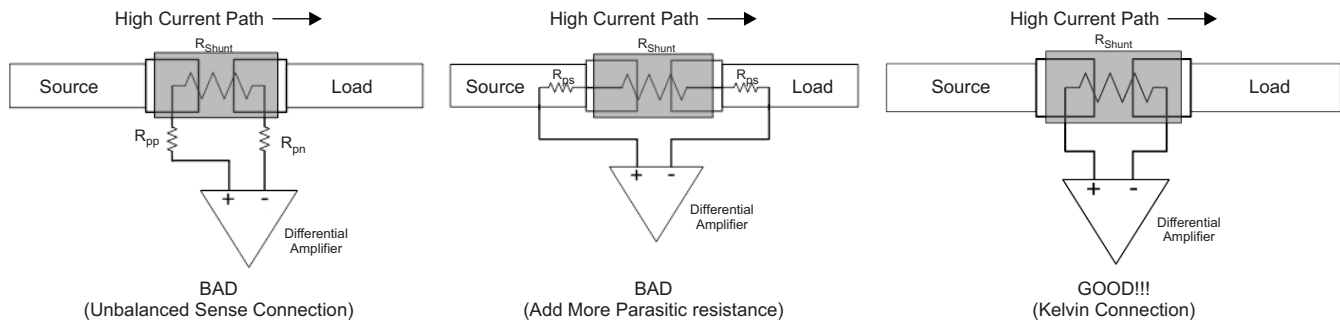
**Maximum voltage loss =  $V_{SH (MAX)} = 80 \text{ mV}$**

**Example:** If the  $V_{BUS} = 24 \text{ V}$ , then the minimum voltage delivered to the load is:

$$V_{L (MIN)} = V_{BUS} - V_{SH (MAX)} = 24 \text{ V} - 0.080 \text{ V} = 23.92 \text{ V}$$

Make sure the minimum voltage delivered meets the minimum voltage requirement of the load.

**4.2 Recommended PCB Layout for  $R_{SH}$**



Be aware of PCB layout parasitic:

- Always ensure that the sense resistor is Kelvin-connected.
- Make the input traces as short as possible.
- Make the input traces as balanced as possible.
- Place the current sensing device and shunt on the same side of the PCB.
- To determine an error contributed by device, measure the voltage across device pins not across the sense resistor.

**4.3 Transient Protection**

In industrial and automotive environments, electronic devices can be subjected to wide input voltage variations resulting from operating relays, solenoid switching, inductive load kick-back, load dump pulses, and reverse polarity. A load dump condition occurs when the load from the generator delivering current is abruptly disconnected. A load dump condition can be up to +80 V. Battery polarity reversal causes a negative input of common mode voltage up to -12 V. In the event the device is exposed to transients on input in excess of its ratings, then external transient absorbers (zener or TVS diodes) are required. The TVS safeguards sensitive devices and common circuitry by clamping the voltage level and diverting transient currents when a trigger voltage is reached. This design uses two unidirectional transient voltage suppressors in series with opposite polarities on VIN+ and VIN- pins to take care of the asymmetrical common mode voltage rating of the device. The two series opposite zener diode D1 and D2 placed between the differential inputs of INA282 make sure the differential input voltage never exceeds its absolute maximum rating of ±5 V.

$$\text{Pulse Current} = I_p = \frac{(1000 \text{ V} - V_C)}{Z_S + R_S} \tag{3}$$

When  $V_C$  is the clamping voltage of TVS at  $I_p$ :

$Z_S$  is the source impedance of the EFT pulse generator and  $R_S$  is the external series filter resistance.

$Z_S = 50 \Omega$  and  $R_S = 10 \Omega$ .

$$\text{Clamping Voltage} = V_C = \frac{I_P}{I_{PP(MAX)}} [V_{C(MAX)} - V_{BR(MAX)}] + V_{BR(MAX)} \quad (4)$$

$$\text{Pulse Power Dissipation} = P_P = V_C \times I_P \quad (5)$$

### D3 and D5 TVS Selection:

Usually select a TVS diode having a stand-off voltage or working voltage greater than the maximum expected  $V_{BUS}$  so that the TVS does not operate or interfere during the normal operation. For PLC applications, the 24-V supply may go up to 20% higher than 24-V nominal supply voltage. Any positive transient voltages are quickly clamped below 80 V.

This is why  $28.8 \text{ V} < V_R$  and  $V_{C(MAX)} < 80 \text{ V}$  (Maximum common mode voltage rating of the device).

### D4 and D6 TVS Selection:

For any negative transient voltages, select a TVS diode that clamps before reaching 14 V.

Once the primary selection is done, solve equations 1, 2, and 3 to find-out the following parameters which are important for TVS selection:

- Pulse current ( $I_P$ ) flowing through the TVS
- Clamping voltage ( $V_C$ ) across the TVS at  $I_P$
- Pulse power ( $P_{PP}$ ) in the TVS at  $V_C$  and  $I_P$

Make sure clamping voltage across D3 and D5 does not exceed 80 V (in fact, the clamping voltage should be well within 80 V) during a 1-kV positive fast transient event. Likewise, make sure clamping the voltage across D4 and D6 does not exceed 14 V (in fact, should be well within 14 V) during 1-kV negative fast transient event.

Make sure the pulse power dissipation in any of the TVSs exceed their maximum allowed peak pulse power dissipation ratings.

To perform the transient protection job, the following TVS diodes have been selected:

### D3 and D5:

SMBJ40A (Rating:  $V_R = 40 \text{ V}$ ,  $V_{C(MAX)} = 64.5 \text{ V}$  at  $I_{PP(MAX)} = 9.3 \text{ V}$  and  $P_{PP(MAX)} = 600 \text{ W}$  at 10/1000  $\mu\text{s}$  or greater than 10 kW at 5/50 ns).

Use the TVS ratings; solve for equations 1, 2, and 3 for  $I_P$ ,  $V_C$  and  $P_P$ :

$$I_P = 15.42 \text{ A}$$

$V_C = 74.7 \text{ V}$ , which is less than 80 V common mode voltage rating of INA282.

$$P_P = V_C \times I_P = 1152 \text{ W}$$

**D4 and D6:** SMAJ7.0A (Rating:  $V_R = 7 \text{ V}$ ,  $V_{C(MAX)} = 12 \text{ V}$  at  $I_{PP(MAX)} = 33.3 \text{ V}$  and  $P_{PP(MAX)} = 400 \text{ W}$  at 10/1000  $\mu\text{s}$  or greater than 10 kW at 5/50 ns)

Use the TVS ratings; solve for equations 1, 2, and 3 for  $I_P$ ,  $V_C$  and  $P_P$ :

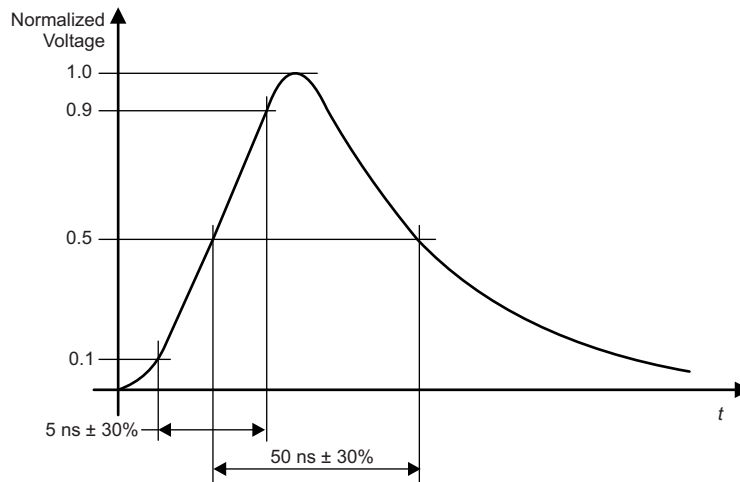
$$I_P = 16.5 \text{ A}$$

$V_C = 10.3 \text{ V}$ , which is less than 14-V common mode voltage rating of INA282.

$$P_P = V_C \times I_P = 170 \text{ W}$$

The rise and fall time for an EFT pulse are 5 ns and 50 ns, respectively, as illustrated in [Figure 3](#). The pulse width is 55 ns (less than 0.1  $\mu\text{s}$ ).





**Figure 3. EFT Pulse**

The SMBJ40A and SMAJ7.0A transient voltage suppressors in the design have peak pulse power ratings of 600 W and 500 W, respectively, when tested with a convention of 10/1000  $\mu$ s double exponential waveform. The TVS manufacturer provides a peak pulse power versus pulse time graph, which shows how a shorter or longer duration affects the peak pulse power of a TVS. For shorter pulse widths, TVS can withstand higher peak pulse power. Therefore, for 5/50 ns EFT pulses, SMBJ40A and SMAJ7.0A transient voltage suppressors can sustain more than 10 kW peak pulse power.

#### 4.4 Input Filter

TI placed an EMI/RFI filter network between the sense resistor and the INA282 device input pins to reject any ac noise, fast transients and current spikes. EFT bursts is a wideband phenomenon with spectral components up to hundreds of MHz. EFT bursts appear as common mode pulses to the high side current shunt monitor devices. The input filter uses RC components to provide both common-mode and differential filtering. The common mode filter uses 0.033  $\mu$ F/2 kV Y-Cap to take care of high voltage high frequency common mode transients (EFT bursts).

The differential filter cut-off frequency is calculated as:

$$F_{DMC} = \frac{1}{2\pi \times [R1 + R2] \times \left[ \left( \frac{C2 \times C4}{C2 + C4} \right) + C3 \right]} = \frac{1}{2\pi \times 2 \times 10 \Omega \times 0.8365 \mu F} \quad (6)$$

$$F_{DMC} = 9.6 \text{ kHz (approximately)}$$

Adding any external filter resistor in series with the current shunt monitor's input will cause additional gain error and degrade CMR due to resistance value mismatch.

$$\% \text{ Gain Error} = 100 - 100 \times \frac{R_{IN}}{R_{IN} + R_{FILTER}} = 100 - 100 \times \frac{6K}{6K + R_{FILTER}} \quad (7)$$

$R_{IN}$  is the internal input impedance of the INA282 current shunt monitor.

If the inputs use a pair of 10- $\Omega$ , 1% resistors, additional gain error will be 0.1664%. To ensure better accuracy, the filter resistor should be less than or equal to 10  $\Omega$ . The engineer can also determine the worst-case gain error by inserting extreme tolerances of  $R_{FILTER}$  and  $R_{IN}$  in the above equation. Therefore, the filter resistor must have 1% tolerance or better.

## 4.5 Source of Errors

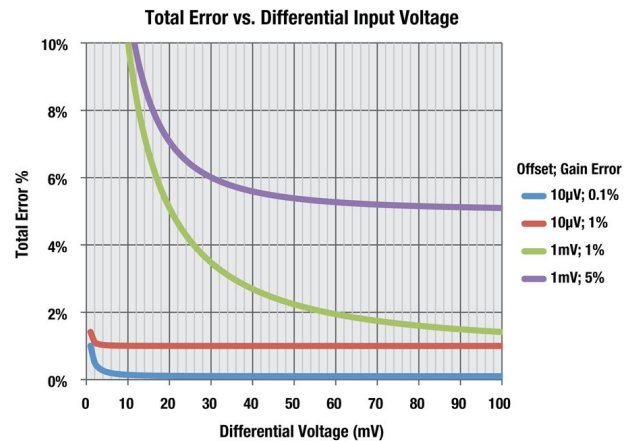
The following list includes all the possible error sources:

- Input offset voltage
- Input offset voltage drift with temperature
- Input offset voltage drift with time
- Input offset current
- Gain error
- Linearity error
- Common mode rejection
- Power supply rejection
- Sense resistor tolerance
- Reference common mode rejection
- Addition gain error due to external filter resistance mismatch

Refer to the **CALCULATING TOTAL ERROR** section of the INA282 datasheet ([SBOS485](#)) for information about how these errors affect the overall accuracy.

For small differential signals at the input, the error is dominated by the amplifier's offset voltage. Low input offset is critical to achieving accurate measurements at the low end of the dynamic range.

For large differential signals at the input, the error is dominated by the amplifier's gain error.



## 5 EFT Test Setup

Example EFT test setups are illustrated in [Figure 4](#) and [Figure 5](#).

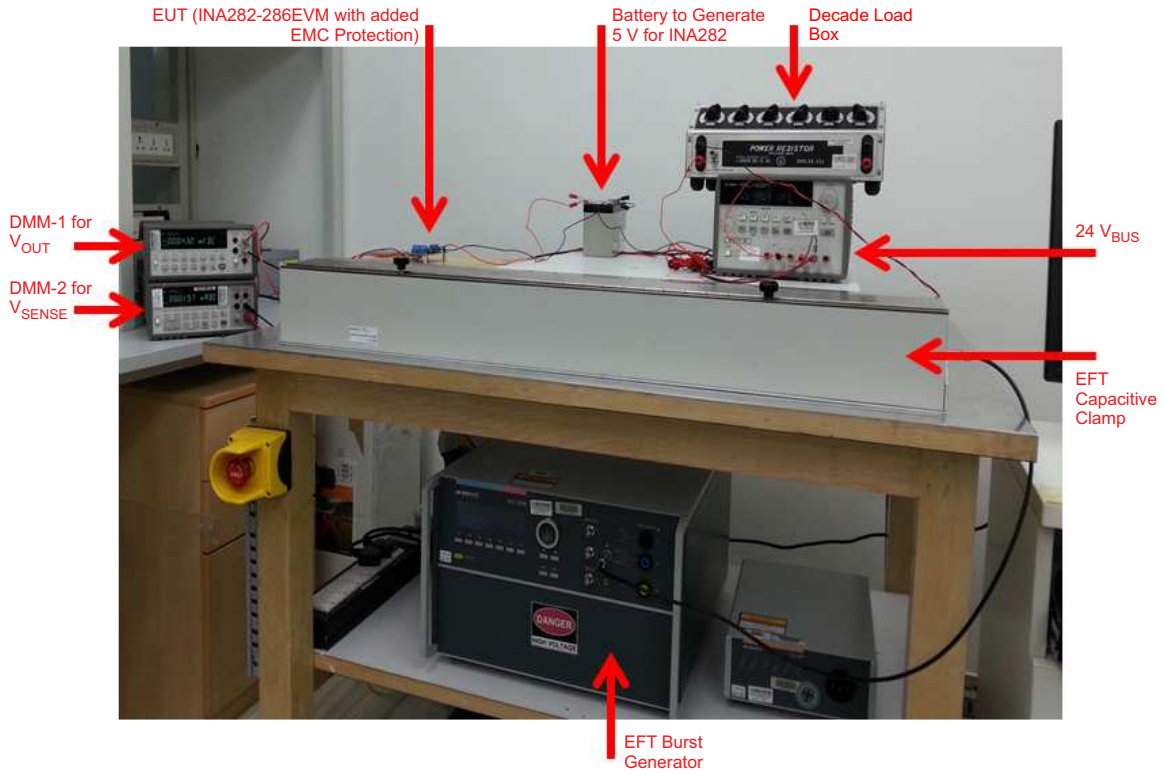


Figure 4. EFT Test Setup View 1

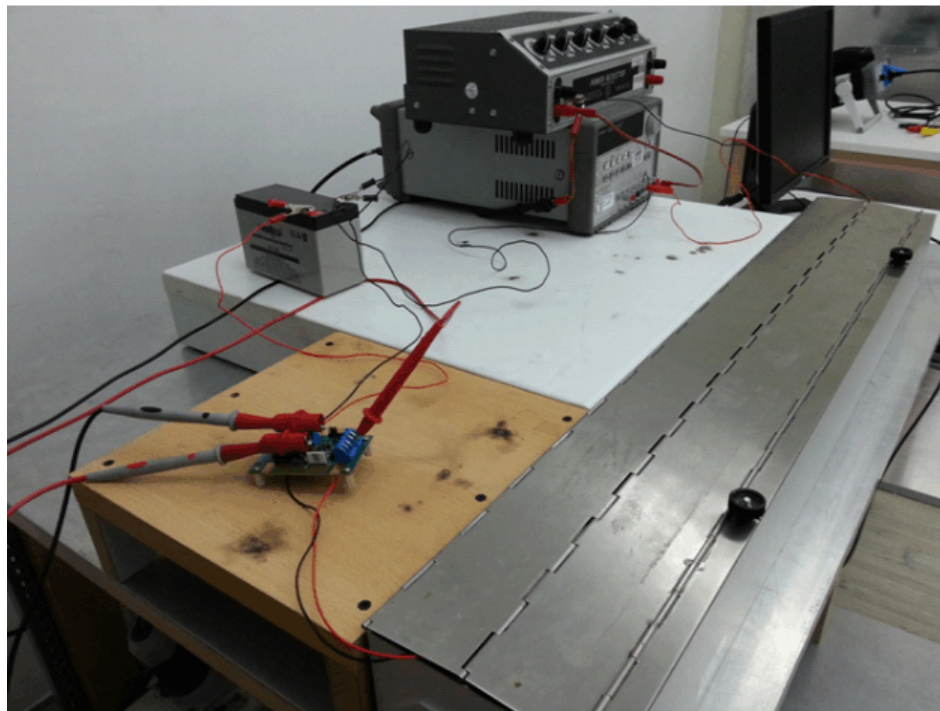


Figure 5. EFT Test Setup View 2

The EFT test setup consists of:

- Two 6½ digital multi-meters (DMMs) → One DMM measures  $V_{SH}$  and other measures  $V_{OUT}$
- EUT → Modified INA282-286EVM
- Battery → Provides 5 VDC supply to INA282 device
- 24-V regulated power supply → Used as 24-V load supply
- EFT burst generator → Generates the 1 kV, 5 kHz and 100 kHz EFT burst pulses for 1 minute duration
- Capacitive clamp → To couple EFT pulses to the EUT as a common mode input voltage
- Decade box load → Used to set the desired load value

The two DMMs are put in MIN-MAX mode to capture and log the minimum and maximum excursions on  $V_{SH}$  and  $V_{OUT}$  during the application of EFT pluses. After the test is complete, minimum and maximum values of  $V_{SH}$  and  $V_{OUT}$  are retrieved from the DMMs. Later these values are used to calculate the accuracy.

## 6 Pre-Compliance EFT Test Results

The design has been implemented utilizing an existing high-side current monitor evaluation module (INA282-286EVM) and the module was modified to add the low pass filter, zener diodes and TVS to meet the EFT bursts test as per IEC61000-4-4. The output voltage accuracy can be calculated as:

$$\% \Delta V_{OUT} = \frac{\text{Measured Output Voltage} - \text{Theoretical Output Voltage}}{\text{Theoretical Output Voltage}} = \frac{V_{OUT} - (\text{GAIN} \times V_{SH})}{\text{GAIN} \times V_{SH}} \times 100 \quad (8)$$

**Test Conditions:** the following conditions apply to the results shown in [Table 1](#) and [Table 2](#):  $V_{BUS} = 24$  VDC,  $V_{+} = 5$  VDC, Device used is INA282,  $\text{GAIN}_{\text{INA282}} = 50$  V/V, Load resistance = 30.0  $\Omega$  and  $R_{SH} = 0.1$   $\Omega$  at 25°C.

**Table 1. Test 1**

Test Name/Condition	Shunt Voltage ( $V_{SH}$ )	Output Voltage ( $V_{OUT}$ )	% Error
Functional	80.870 mV	4.0390 V	0.1113%

**Table 2. Test 2 EFT Burst**

Test Name/Condition	Shunt Voltage ( $V_{SH}$ )	Output Voltage ( $V_{OUT}$ )	% Error
1000 V, 100 kHz, negative pulses	80.471441 mV	4.069547 V	1.143%
1000 V, 100 kHz, positive pulses	81.10343 mV	4.017819 V	0.9211%
1000 V, 5 kHz, negative pulses	80.93304 mV	4.036456 V	0.252%
1000 V, 5 kHz, positive pulses	80.99869 mV	4.036590 V	0.33%

## 7 Conclusion

The reference design presents the details for designing high-side current shunt monitors with EMC protection that meets an overall accuracy of 2%. Adding an external filter to the current shunt monitor might degrade the performance unless designed with appropriate considerations. TI offers INA282 voltage-output with high-side current sense monitors. These monitors solve the common and often challenging problem of measuring high-side current, especially when common-mode dynamics go negative below ground. The common-mode voltage range for the INA282 is independent of the supply voltage. The zero-drift architecture, unique input stage topology, and the precisely trimmed internal resistor of the INA282 experiences very low offset voltage and offset drift over temperature and time that is crucial to maintain accuracy in high voltage applications with a high degree of dynamic changes in common-mode voltage.



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